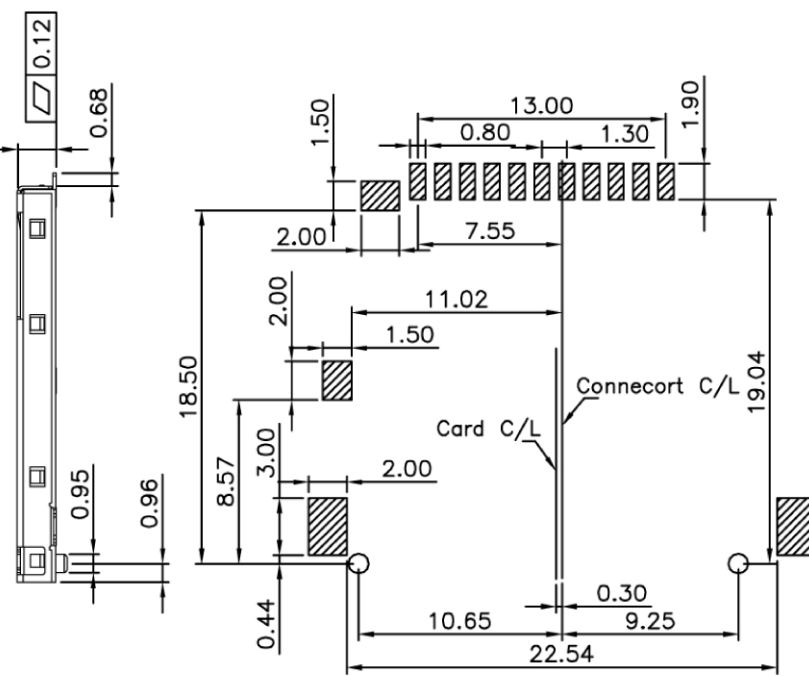
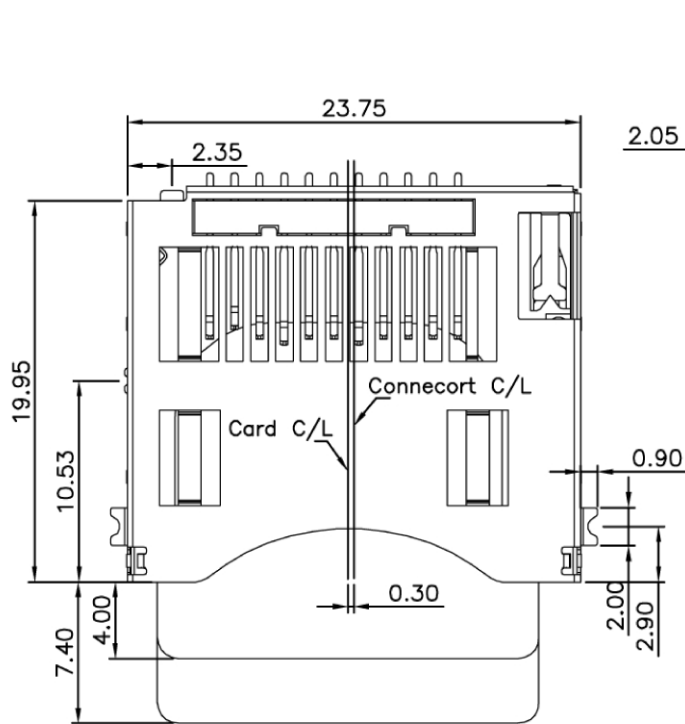


版次 REV	變更通知單號 ECN NO	說明 DESCRIPTION	日期 DATE	修改 DRAW	核准 APPROVE



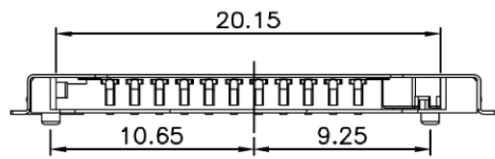
Pad Area
PCB LAYOUT TOP VIEW
(TOLERANCE:±0.05)

Specification
*Electrical Characteristics:
Contact Current Rating:0.5 Amperes.
Dielectric Withstanding Voltage:AC500V r.m.s.
Insulation Resistance:1000 MΩ Minimum.
Contact Resistance:40 mΩ Maximum.
*Environmental:
Operating Temperature:-25°C~+90°C.
*Environmental:
Mating Cycles:10,000 Insertions.
*Mechanical Characteristics:
Card Push Insertion/Out Force:0.7~1.20kgf.
Contact Separation Force:0.20kgf Minimum.
*Material:
Insulator:HI-Temp Plastic UL 94V-0 Rated.
Contact:Copper Alloy(t=0.15mm).
Shell:Stainless Steel(t=0.20mm).
Spring:SWP.

P/N: SD016-XXXXXX-0

Insulator Material ————
L1:LCP
Insator Colorul ————
B:Black
Special Code ————
0:Normal
Packing Mode ————
C:Tray
R:Reel

Contact Plating Code: ————
Lead Plated
T1:Solder Tail Tin/Contact Area 1u"
T2:Solder Tail Tin/Contact Area 3u"
T3:Solder Tail Tin/Contact Area 5u"
T4:Solder Tail Tin/Contact Area 10u"
unLead Plated
S1:Solder Tail Tin/Contact Area 1u"
S2:Solder Tail Tin/Contact Area 3u"
S3:Solder Tail Tin/Contact Area 5u"
S4:Solder Tail Tin/Contact Area 10u"



1	DAT1	MIDDLE	7	NC	MIDDLE
2	DAT0	MIDDLE	8	VCC	LONG
3	VDD	MIDDLE	9	CMD	MIDDLE
4	CLK	MIDDLE	10	CD/DAT3	SHORT
5	CLK	LONG	11	DAT2	MIDDLE
6	CLK	MIDDLE			

DETECT SWITCH
1.CARD INSERTING POSITION OPEN
2.NO CARD POSITION CLOCK

P/N # SD016-L1BS1C-0

張數 SHEET	1/1	單位 UNIT	MM	公差 TOLERANCE	UNLESS	名稱 TITLE	圖號 DWG NO.	料號 PART NO.	P/N # SD016-L1BS1C-0
日期 DATE	07.06.10	角法 PROJ.							
製圖 DRAWN	taji	版本 REV.	A	X±0.40					
審核 CHECKED	Long July06,2010	比例 SCALE	1:2	X±0.30					
核准 APPROVE	Chin July06,2010	客戶圖 CUSTOMER DRAWING		XX±0.20					
				X*±5°					



Wellco T&C Co., Ltd.